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N-Channel Shielded Gate PowerTrench[®] MOSFET 150 V, 2.3 A, 144 m Ω

Features

- Shielded Gate MOSFET Technology
- Max $r_{DS(on)}$ = 144 m Ω at V_{GS} = 10 V, I_D = 2.3 A
- Max $r_{DS(on)}$ = 188 m Ω at V_{GS} = 6 V, I_D = 1.9 A
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability in a widely used surface mount package
- Fast switching speed
- 100% UIL Tested
- RoHS Compliant

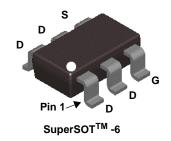


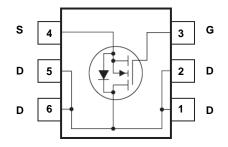
General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that incorporates Shielded Gate technology. This process has been optimized for $r_{DS(on)}$, switching performance and ruggedness.

Applications

- Load Switch
- Synchronous Rectifier
- Primary Switch





MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DS}	Drain to Source Voltage		150	V
V_{GS}	Gate to Source Voltage		±20	V
	Drain Current -Continuous	(Note 1a)	2.3	^
'D	-Pulsed		10	_ A
E _{AS}	Single Pulse Avalanche Energy	(Note 3)	12	mJ
Б	Power Dissipation	(Note 1a)	1.6	W
P_{D}	Power Dissipation	(Note 1b)	0.8	VV
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	30	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1	a) 78	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
.244	FDC86244	SSOT-6	7 "	8 mm	3000 units

Electrical Characteristics $T_J = 25$ °C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	150			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		103		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 120 V, V _{GS} = 0 V			1	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA

On Characteristics

V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	2.0	2.5	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		-9		mV/°C
		$V_{GS} = 10 \text{ V}, I_D = 2.3 \text{ A}$		113	144	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 6 \text{ V}, I_D = 1.9 \text{ A}$		128	188	mΩ
-(-,		$V_{GS} = 10 \text{ V}, I_D = 2.3 \text{ A}, T_J = 125 ^{\circ}\text{C}$		214	273	
9 _{FS}	Forward Transconductance	$V_{DD} = 5 \text{ V}, I_{D} = 2.3 \text{ A}$		6		S

Dynamic Characteristics

C _{iss}	Input Capacitance	V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz	260	345	pF
Coss	Output Capacitance		32	45	pF
C _{rss}	Reverse Transfer Capacitance		1.7	5	pF
R_q	Gate Resistance		1.3		Ω

Switching Characteristics

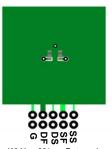
t _{d(on)}	Turn-On Delay Time			4	1.7	10	ns
t _r	Rise Time	$V_{DD} = 75 \text{ V}, I_D = 2.3 \text{ A},$			1.4	10	ns
t _{d(off)}	Turn-Off Delay Time	V _{GS} = 10 V, R _{GEN} =	$V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$		10	20	ns
t _f	Fall Time			3	3.1	10	ns
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$		4	1.2	6	nC
	Total Gate Charge	$V_{GS} = 0 V to 5 V$	V _{DD} = 75 V	2	2.4	4	nC
Q_{gs}	Total Gate Charge		$I_D = 2.3 \text{ A}$		0.1		nC
Q_{gd}	Gate to Drain "Miller" Charge				1.0		nC

Drain-Source Diode Characteristics

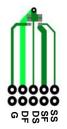
V_{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = 2.3 \text{ A}$ (Note 2)	8.0	1.3	V
t _{rr}	Reverse Recovery Time	I _E = 2.3 A, di/dt = 100 A/μs	45	73	ns
Q _{rr}	Reverse Recovery Charge	1F = 2.5 A, α/αι = 100 A/μ5	33	53	nC

NOTES

 $R_{0,UG}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{0,UG}$ is guaranteed by design while $R_{0,GA}$ is determined by the user's board design.



a. 78 °C/W when mounted on a 1 in² pad of 2 oz copper



b.175 °C/W when mounted on a minimum pad of 2 oz copper

- 2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0 %.
- 3. Starting T $_J$ = 25 °C, L = 1.0 mH, I $_{AS}$ = 5.0 A, V $_{DD}$ = 135 V, V $_{GS}$ = 10 V.

Typical Characteristics T_J = 25 °C unless otherwise noted

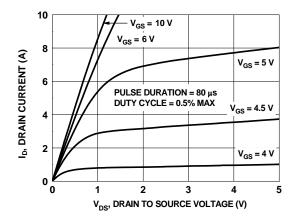


Figure 1. On-Region Characteristics

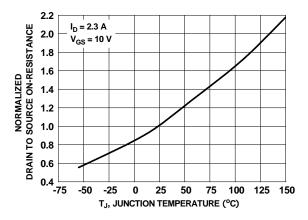


Figure 3. Normalized On-Resistance vs Junction Temperature

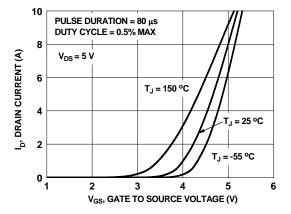


Figure 5. Transfer Characteristics

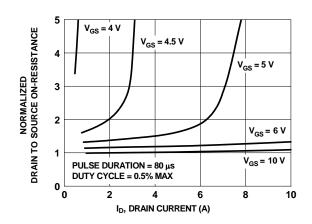


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

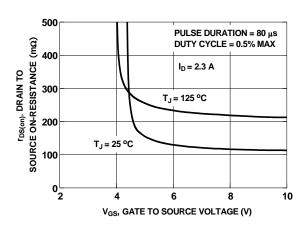


Figure 4. On-Resistance vs Gate to Source Voltage

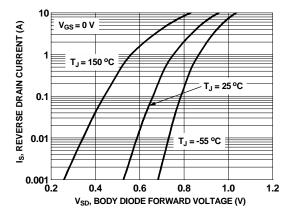


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

Typical Characteristics $T_J = 25$ °C unless otherwise noted

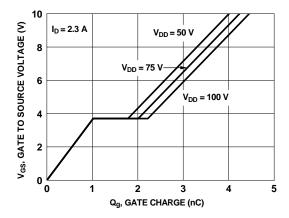


Figure 7. Gate Charge Characteristics

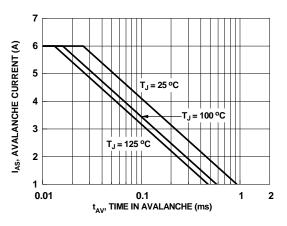


Figure 9. Unclamped Inductive Switching Capability

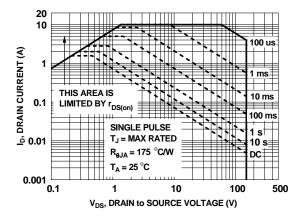


Figure 11. Forward Bias Safe Operating Area

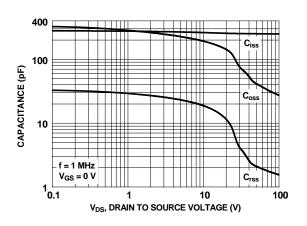


Figure 8. Capacitance vs Drain to Source Voltage

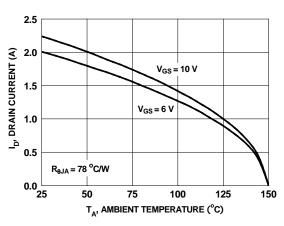


Figure 10. Maximum Continuous Drain Current vs Ambient Temperature

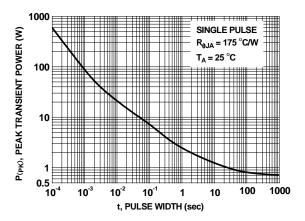


Figure 12. Single Pulse Maximum Power Dissipation

Typical Characteristics $T_J = 25$ °C unless otherwise noted

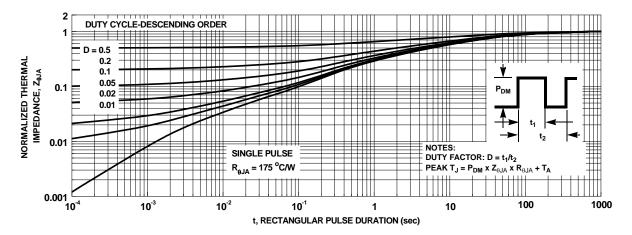
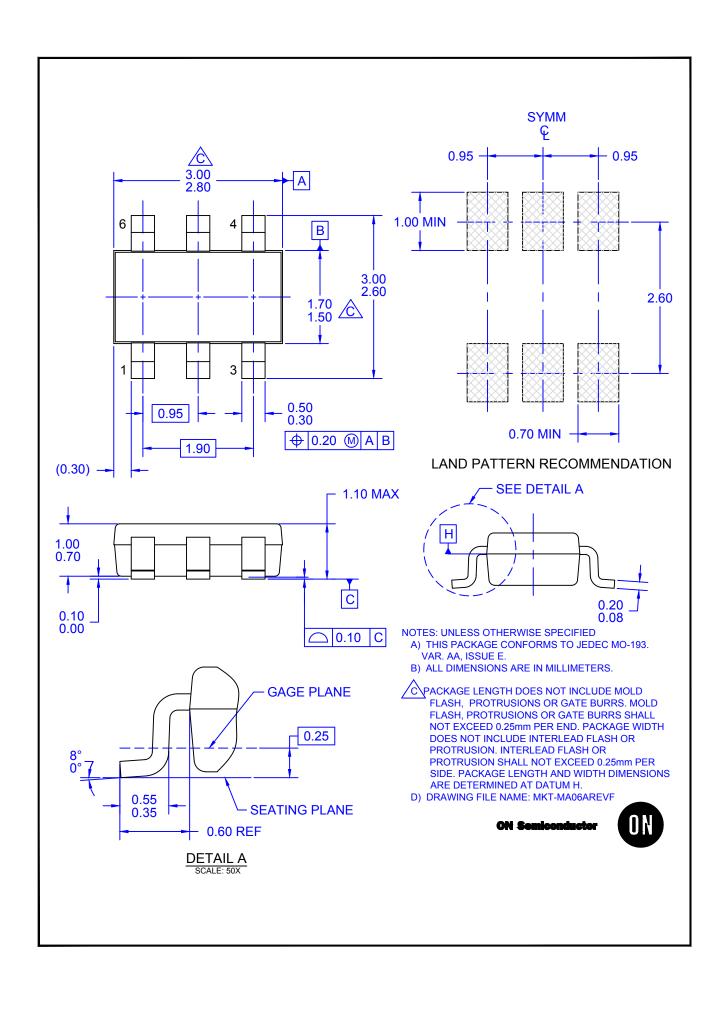


Figure 13. Juncton-to-Ambient Transient Thermal Response Curve



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